

Correction to Atomic Layer Deposition of Ruthenium and Ruthenium Oxide Using a Zero Oxidation State Precursor

Dustin Z. Austin,¹ Melanie A. Jenkins,¹ Derryl Allman, Sallie Hose, David Price, Charles L. Dezelah, and John F. Conley, Jr.*

Chem. Mater. 2017, 29 (3), 1107–1115. DOI: 10.1021/acs.chemmater.6b04251

Due to a faulty thermocouple within the atomic layer deposition (ALD) chamber, all ALD temperatures reported in the manuscript are higher than the actual temperatures used by a nonconstant amount ranging from ~25 °C for the lowest temperatures to ~40 °C for the highest temperatures used.

The corrected figures and tables with temperatures are below:

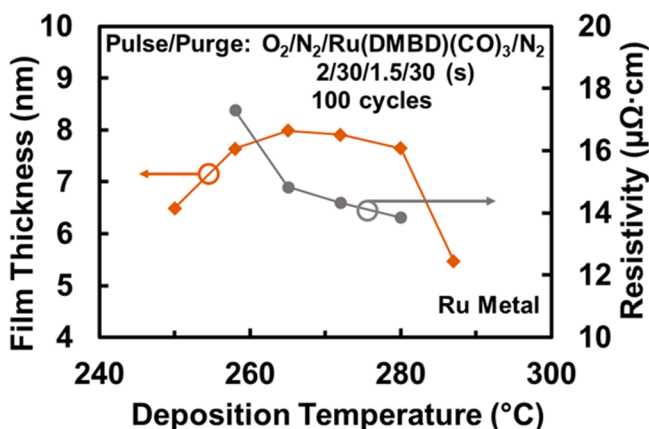


Figure 2. ALD Ru metal-film thickness and resistivity vs deposition temperature.

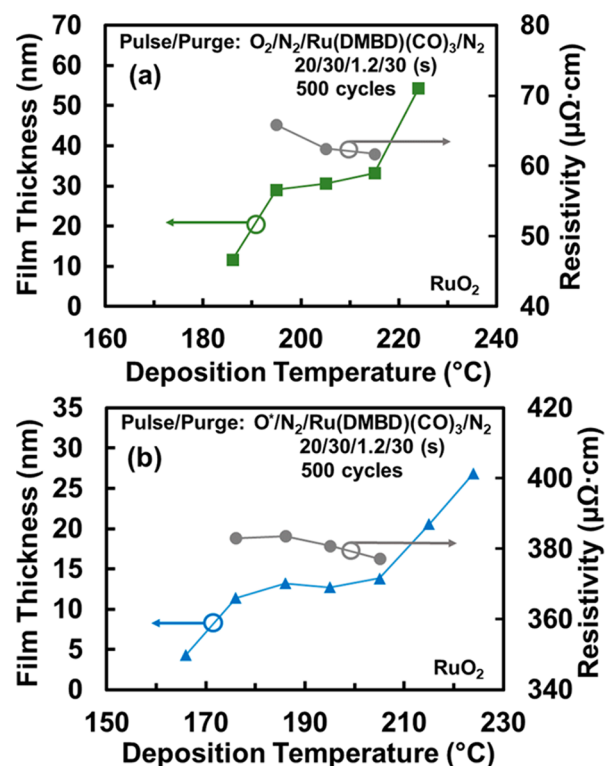


Figure 8. RuO₂-film thickness and resistivity vs deposition temperature for (a) thermal ALD and (b) PEALD.

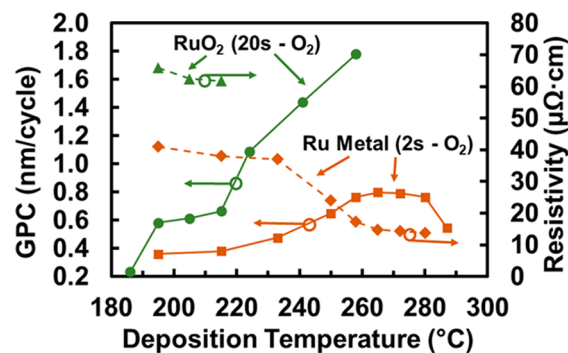


Figure 14. Comparison of GPC and resistivity vs temperature for Ru and RuO₂ thermal ALD processes. The 20 s O₂ pulses in green circles

Published: December 7, 2018

Table 1. Comparison of Ruthenium Precursors for Thermal ALD Ru Processes Using O₂ as a Co-Reactant

precursor	metal oxidation state	nucleation (no. of cycles)	growth rate (nm/cycle)	ALD window (°C)	resistivity ($\mu\Omega$ cm)	refs
Ru(thd) ₃	+3	~250	0.036	325–450	15–20	17
Ru(EtCp) ₂	+2	~210 ¹³	0.049 ¹³	uncertain ⁷	15 ¹³	6–9, 12, 13
Ru(Cp) ₂	+2	~250 ¹⁶	0.045 ¹⁶	325–375 ¹⁶	13 ¹⁶	16, 18
ECPR	+2	~25 ²⁰	0.09 ²⁰	uncertain ²⁰	22–26 ²⁰	19, 20
DMPR	+2	~60	0.022	250–320	18–24	21
Cyprus	+2	~20	0.05	250–310	20	22
Ru(DMPD) ₂	+2	~40 ²³	0.012 ²³	185–210 ²³	17 ²⁴	23, 24
Ru(Cp)(CO) ₂ Et	+2	~85 ²⁵	0.1 ²⁵	300–325 ²⁶	16 ²⁵	25, 26
(HD) ¹ PrMePhRu	0	3	0.076	270–350	29–36	28
IMBCHDRu	0	~10 ²⁹	0.089 ²⁹	225–270 ²⁹	30–40 ²⁹	29, 30
EBCHDRu	0	3	0.1	200–275	18	31
EBECHDRu	0	3	0.042	175–275	20	32
EBBDRu	0	15	0.056	not available	26	33
Ru(DMBD)(CO) ₃	0	~0	0.067	255–280	14	this work

Table 2. Comparison of Ruthenium Precursors for RuO₂

precursor	metal oxidation	nucleation (cycles)	growth rate (nm/cycle)	ALD window (°C)	resistivity ($\mu\Omega$ cm)	refs
Ru(EtCp) ₂	+2	~700 ⁶	0.175 ⁹	not available	70 ⁹	6, 8, 9
Ru(Cp) ₂	+2	not available	0.32	not available	270	18
Ru(DMPD) ₂	+2	~125	0.023	not available	not available	23
(HD) ¹ PrMePhRu	0	~50	0.15	180–200	275	28
EBCHDRu	0	2	0.186	not available	118	34
EBBDRu	0	6	0.09	not available	~140	33
Ru(DMBD)(CO) ₃	0	35	0.065	195–215	62	this work

(GPC) and green triangles (resistivity) and 2 s O₂ pulses in orange squares (GPC) and orange diamonds (resistivity).